



TFW

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the below date:
Date: 2/28/05 Name: Anthony P. Curtis, Ph.D., 46,193 Signature:

**BRINKS
HOFFER
GILSON
& LIONE****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Appln. of: Kuang Chien Hseih et al.

Appln. No.: 10/680,509

Filed: October 7, 2003

For: Adhesive Bonding With Low Temperature
Grown Amorphous or Polycrystalline
Compound Semiconductors

Examiner: Vikki Trinh

Art Unit: 2811

Attorney Docket No: 10322/57

Mail Stop Amendment
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL

Sir:

Attached is/are:

- ☒ Transmittal Cover Letter (1p. Filed in Dup.); Amendment (9pp.)
☒ Return Receipt Postcard

Fee calculation:

- ☒ No additional fee is required.
☐ Small Entity.
☐ An extension fee in an amount of \$_____ for a _____-month extension of time under 37 C.F.R. § 1.136(a).
☐ A petition or processing fee in an amount of \$_____ under 37 C.F.R. § 1.17(____).
☐ An additional filing fee has been calculated as shown below:

					Small Entity			Not a Small Entity	
	Claims Remaining After Amendment		Highest No. Previously Paid For	Present Extra	Rate	Add'l Fee	or	Rate	Add'l Fee
Total	54	Minus	71	0	x \$25=			x \$50=	
Indep.	3	Minus	3	0	x 100=			x \$200=	
First Presentation of Multiple Dep. Claim					+\$180=			+\$360=	
					Total	\$		Total	\$

Fee payment:

- ☐ A check in the amount of \$_____ is enclosed.
☐ Please charge Deposit Account No. 23-1925 in the amount of \$_____. A copy of this Transmittal is enclosed for this purpose.
☐ Payment by credit card in the amount of \$_____ (Form PTO-2038 is attached).
☒ The Director is hereby authorized to charge payment of any additional filing fees required under 37 CFR § 1.16 and any patent application processing fees under 37 CFR § 1.17 associated with this paper (including any extension fee required to ensure that this paper is timely filed), or to credit any overpayment, to Deposit Account No. 23-1925.

Date

2/28/05

Respectfully submitted,

Anthony P. Curtis, Ph.D (Reg. No. 46,193)



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P.O. Box 1450
Alexandria, VA 22313-1450
on 2/28/05

Date of Deposit

Anthony P. Curtis, Ph.D., Reg. No. 46,193

Name of applicant, assignee or
Registered Representative

Signature

2/28/05

Date of Signature

Our Case No. 10322/57

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kuang Chien Hsieh et al.

Serial No. 10/680,509

Filing Date: October 7, 2003

For ADHESIVE BONDING WITH LOW
TEMPERATURE GROWN
AMORPHOUS OR
POLYCRYSTALLINE COMPOUND
SEMICONDUCTORS

Examiner: Vikki Trinh

Group Art Unit No. 2811

AMENDMENT

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of January 26, 2005, please amend the application as follows:

Amendments to the Claims begin on page 2 of this paper.

Remarks are provided on page 9 of this paper.